

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Geng-Shin SHEN	06/23/2010
Wu-Chang TU	06/24/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	CHIPMOS TECHNOLOGIES INC
<b>Street Address:</b>	No.1, R&D Rd.1, Science-Based Industrial Park
<b>City:</b>	Hsinchu City
<b>State/Country:</b>	TAIWAN
<b>Name:</b>	CHIPMOS TECHNOLOGIES (BERMUDA) LTD
<b>Street Address:</b>	Canon's Court, 22 Victoria Street,
<b>City:</b>	Hamilton
<b>State/Country:</b>	BERMUDA
<b>Postal Code:</b>	HM12
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12827133
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(206)203-2603
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<b>ATTORNEY DOCKET NUMBER:</b>	TW-GNA-0739CA2

OP \$40.00 12827133

**501220278**

**PATENT**  
**REEL: 024617 FRAME: 0068**

NAME OF SUBMITTER:

Ming Chow

Total Attachments: 2

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ASSIGNMENT DEED

This assignment agreement is applicable to an invention entitled (invention title) \_\_\_\_\_

Stacked Chip Package Structure with Leadframe Having Bus Bar

This PATENT RIGHT referred to in this agreement is (check one):

a Patent Application for this invention, executed by the ASSIGNOR(S) concurrently with this Agreement.

U.S. Patent Application Serial No. \_\_\_\_\_, filed on \_\_\_\_\_.

U.S. patent No. \_\_\_\_\_, issued on \_\_\_\_\_.

The PATENT RIGHT assigned under this agreement is:

U.S. Patent rights only

worldwide Patent rights (the assignee shall have the right to claim the benefit for the filing date of any U.S. Patent Application identified above).

The ASSIGNOR(S) referred to in this agreement is (or are):

SHEN, GENG-SHIN (full name of first assignor)

No.1. R&D Rd.1, Science-Based Industrial Park, Hsinchu city, Taiwan(R.O.C.) (address)

The ASSIGNOR(S) referred to in this agreement is (or are):

TU, WU-CHANG (full name of second assignor)

No.1. R&D Rd.1, Science-Based Industrial Park, Hsinchu city, Taiwan(R.O.C.) (address)

The ASSIGNOR(S) referred to in this agreement is (or are):

\_\_\_\_\_ (full name of third assignor)

\_\_\_\_\_ (address)

The ASSIGNOR(S) referred to in this agreement is (or are):

\_\_\_\_\_ (full name of fourth assignor)

\_\_\_\_\_ (address)

The First ASSIGNEE referred to in this agreement is:

CHIPMOS TECHNOLOGIES INC (full name of first assignee)

No.1. R&D Rd.1, Science-Based Industrial Park, Hsinchu city, Taiwan(R.O.C.) (address)

Is (check one):  an individual  a partnership  a Corporation of Taiwan(R.O.C.) (State or Country)

The second ASSIGNEE referred to in this agreement is:

CHIPMOS TECHNOLOGIES (BERMUDA) LTD (full name of first assignee)

Canon's Court, 22 Victoria Street, Hamilton HM 12, Bermuda (address)

Is (check one):  an individual  a partnership  a Corporation of Bermuda (State or Country)

The ASSIGNOR(S), in consideration of \$1.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, have and do hereby assign the following to each ASSIGNEE, their successors and assigns:

ASSIGNMENT DEED

the full and exclusive right to the invention;  
an equal interest in and to the entire right, title and interest in and to the PATENT RIGHTS in the invention;  
all continuations, continuations-in-part, divisionals, re-issues, and re-examination patents and patent applications; and  
the right to claim priority under 35 U.S.C. 119, based on any earlier foreign applications for this invention.

As to all U.S. Patent Applications assigned under this Agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Director of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE(S) as the ASSIGNEE(S) of an equal interest in the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE(S), their successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE(S), or their representatives, and facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE(S), make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE(S), their successors and assigns, to obtain an enforced proper protection for said invention.

<u>Jeng-Shin Shen</u> (Signature of sole or first assignor)	<u>Jun/23' 2010</u> (Date)
<u>Wu-Chang Fu</u> (Signature of second assignor)	<u>6/20/2010</u> (Date)
_____ (Signature of third assignor)	_____ (Date)
_____ (Signature of fourth assignor)	_____ (Date)